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What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Obsolete |
| Core Processor | F ² MC-16FX |
| Core Size | 16-Bit |
| Speed | 32MHz |
| Connectivity | CANbus, LINbus, SCI, UART/USART |
| Peripherals | DMA, LVD, POR, PWM, WDT |
| Number of I/O | 37 |
| Program Memory Size | 64KB (64K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 4K x 8 |
| Voltage - Supply (Vcc/Vdd) | 2.7V ~ 5.5V |
| Data Converters | A/D 16x8/10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 125°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 48-LQFP |
| Supplier Device Package | 48-LQFP (7x7) |
| Purchase URL | https://www.e-xfl.com/product-detail/infineon-technologies/mb96f612rbpmc-gse2 |

- LIN functionality working either as master or slave LIN device
- Extended support for LIN-Protocol to reduce interrupt load

A/D Converter

- SAR-type
- 8/10-bit resolution
- Signals interrupt on conversion end, single conversion mode, continuous conversion mode, stop conversion mode, activation by software, external trigger, reload timers and PPGs
- Range Comparator Function

Source Clock Timers

- Three independent clock timers (23-bit RC clock timer, 23-bit Main clock timer, 17-bit Sub clock timer)

Hardware Watchdog Timer

- Hardware watchdog timer is active after reset
- Window function of Watchdog Timer is used to select the lower window limit of the watchdog interval

Reload Timers

- 16-bit wide
- Prescaler with $1/2^1$, $1/2^2$, $1/2^3$, $1/2^4$, $1/2^5$, $1/2^6$ of peripheral clock frequency
- Event count function

Free-Running Timers

- Signals an interrupt on overflow, supports timer clear upon match with Output Compare (0, 4)
- Prescaler with 1, $1/2^1$, $1/2^2$, $1/2^3$, $1/2^4$, $1/2^5$, $1/2^6$, $1/2^7$, $1/2^8$ of peripheral clock frequency

Input Capture Units

- 16-bit wide
- Signals an interrupt upon external event
- Rising edge, Falling edge or Both (rising & falling) edges sensitive

Output Compare Units

- 16-bit wide
- Signals an interrupt when a match with Free-running Timer occurs
- A pair of compare registers can be used to generate an output signal

Programmable Pulse Generator

- 16-bit down counter, cycle and duty setting registers
- Can be used as 2 × 8-bit PPG
- Interrupt at trigger, counter borrow and/or duty match
- PWM operation and one-shot operation

- Internal prescaler allows 1, 1/4, 1/16, 1/64 of peripheral clock as counter clock or of selected Reload timer underflow as clock input
- Can be triggered by software or reload timer
- Can trigger ADC conversion
- Timing point capture

Quadrature Position/Revolution Counter (QPRC)

- Up/down count mode, Phase difference count mode, Count mode with direction
- 16-bit position counter
- 16-bit revolution counter
- Two 16-bit compare registers with interrupt
- Detection edge of the three external event input pins AIN, BIN and ZIN is configurable

Real Time Clock

- Operational on main oscillation (4MHz), sub oscillation (32kHz) or RC oscillation (100kHz/2MHz)
- Capable to correct oscillation deviation of Sub clock or RC oscillator clock (clock calibration)
- Read/write accessible second/minute/hour registers
- Can signal interrupts every half second/second/minute/hour/day
- Internal clock divider and prescaler provide exact 1s clock

External Interrupts

- Edge or Level sensitive
- Interrupt mask bit per channel
- Each available CAN channel RX has an external interrupt for wake-up
- Selected USART channels SIN have an external interrupt for wake-up

Non Maskable Interrupt

- Disabled after reset, can be enabled by Boot-ROM depending on ROM configuration block
- Once enabled, can not be disabled other than by reset
- High or Low level sensitive
- Pin shared with external interrupt 0

I/O Ports

- Most of the external pins can be used as general purpose I/O
- All push-pull outputs
- Bit-wise programmable as input/output or peripheral signal
- Bit-wise programmable input enable
- One input level per GPIO-pin (either Automotive or CMOS hysteresis)
- Bit-wise programmable pull-up resistor

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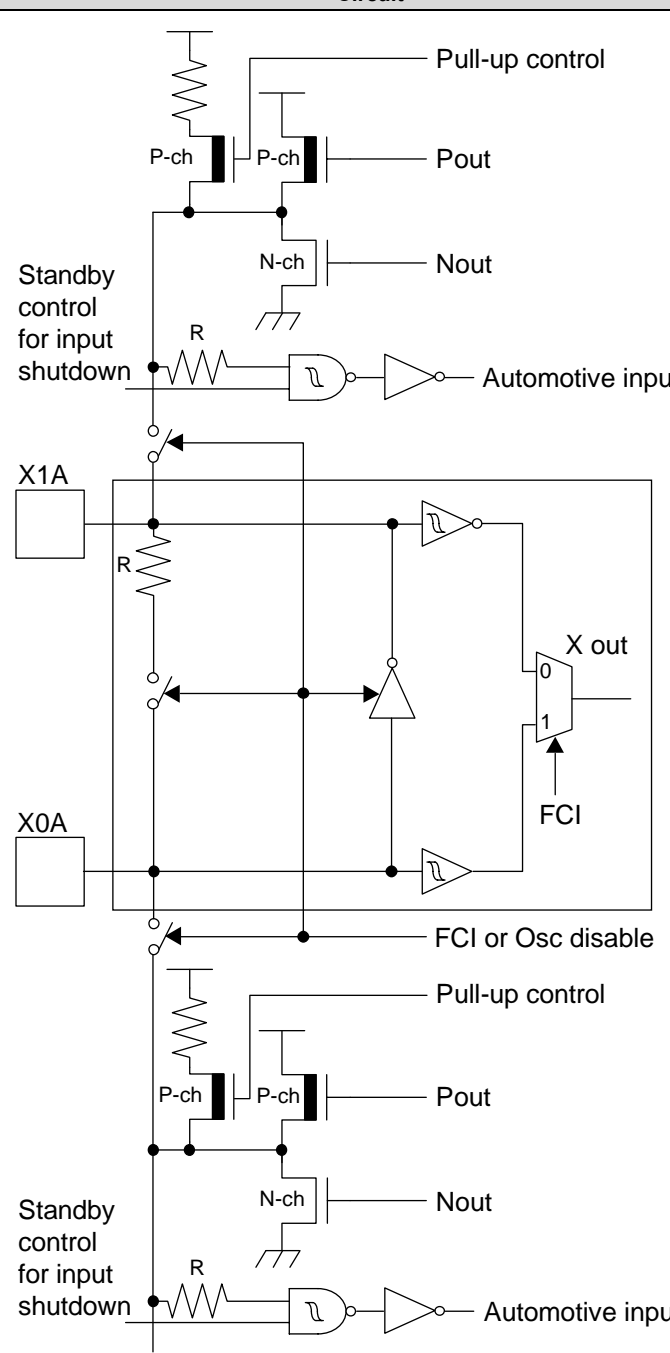
| Pin Name | Feature | Description |
|----------|---------|---|
| ZINn | QPRC | Quadrature Position/Revolution Counter Unit n input pin |

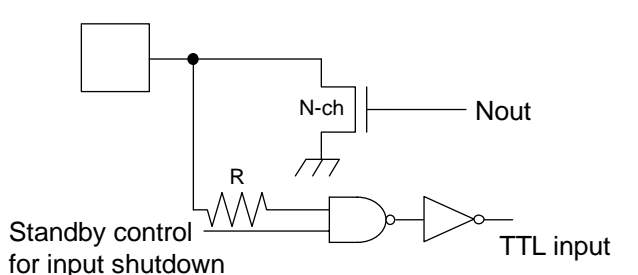
5. Pin Circuit Type

| Pin No. | I/O Circuit Type* | Pin Name |
|---------|-------------------|----------------------------------|
| 1 | Supply | AVss |
| 2 | G | AVRH |
| 3 | K | P06_3 / AN3 / PPG3 |
| 4 | K | P06_4 / AN4 / PPG4 |
| 5 | K | P06_6 / AN6 / PPG6 |
| 6 | K | P06_7 / AN7 / PPG7 |
| 7 | I | P05_0 / AN8 / SIN2 / INT3_R1 |
| 8 | K | P05_1 / AN9 / SOT2 |
| 9 | I | P05_2 / AN10 / SCK2 |
| 10 | K | P05_4 / AN12 / TOT3 / INT2_R |
| 11 | K | P05_6 / AN14 / INT4_R |
| 12 | K | P07_0 / AN16 / INT0 / NMI |
| 13 | B | P04_0 / X0A |
| 14 | B | P04_1 / X1A |
| 15 | C | MD |
| 16 | H | P17_0 |
| 17 | O | DEBUG I/F |
| 18 | M | P00_0 / INT8 / SCK7_R / PPG0_B |
| 19 | H | P00_1 / INT9 / SOT7_R / PPG1_B |
| 20 | M | P00_2 / INT10 / SIN7_R |
| 21 | H | P00_4 / INT12 / SOT8_R / PPG12_B |
| 22 | M | P00_5 / INT13 / SIN8_R / PPG14_B |
| 23 | M | P00_3 / INT11 / SCK8_R / PPG3_B |
| 24 | H | P01_0 / TIN1 / CKOT1 / OUT0_R |
| 25 | H | P01_1 / TOT1 / CKOTX1 / OUT1_R |
| 26 | H | P01_4 / PPG4_B |
| 27 | M | P01_5 / SIN2_R / INT7_R |
| 28 | H | P01_6 / SOT2_R / PPG6_B |
| 29 | M | P01_7 / SCK2_R / PPG7_B |
| 30 | H | P02_0 / PPG12 / CKOT1_R |
| 31 | H | P02_2 / ZIN0 / PPG14 / CKOT0_R |
| 32 | H | P02_4 / AIN0 / IN0 / TTG0 |

| Pin No. | I/O Circuit Type* | Pin Name |
|---------|-------------------|--|
| 33 | C | RSTX |
| 34 | A | X1 |
| 35 | A | X0 |
| 36 | Supply | Vss |
| 37 | Supply | Vcc |
| 38 | F | C |
| 39 | H | P02_5 / BIN0 / IN1 / TTG1 / ADTG_R |
| 40 | K | P03_0 / AIN1 / IN4 / TTG4 / TTG12 / AN24 |
| 41 | K | P03_1 / BIN1 / IN5 / TTG5 / TTG13 / AN25 |
| 42 | M | P03_2 / INT10_R / RX2 |
| 43 | H | P03_3 / TX2 |
| 44 | K | P03_6 / ZIN1 / OUT6 / AN30 |
| 45 | K | P03_7 / OUT7 / AN31 |
| 46 | K | P06_0 / AN0 / PPG0 |
| 47 | K | P06_1 / AN1 / PPG1 |
| 48 | Supply | AVcc |

*: See [I/O Circuit Type](#) for details on the I/O circuit types.

| Type | Circuit | Remarks |
|------|--|--|
| B |  <p>The diagram illustrates the internal circuitry for Type B, which is a low-speed oscillation circuit shared with GPIO functionality. It consists of two identical input/output blocks. Each block features a pull-up control, a P-channel MOSFET (P-out), an N-channel MOSFET (N-out), a standby control for input shutdown, an automotive input, and a multiplexer (X out) controlled by FCI. The circuit also includes a feedback resistor R and internal logic with inverters and a feedback resistor R.</p> | <p>Low-speed oscillation circuit shared with GPIO functionality:</p> <ul style="list-style-type: none"> ■ Feedback resistor = approx. 5.0MΩ ■ GPIO functionality selectable (CMOS level output ($I_{OL} = 4\text{mA}$, $I_{OH} = -4\text{mA}$), Automotive input with input shutdown function and programmable pull-up resistor) |

| Type | Circuit | Remarks |
|------|---|--|
| O |  | <ul style="list-style-type: none"> ■ Open-drain I/O ■ Output 25mA, $V_{cc} = 2.7V$ ■ TTL input |

| Vector Number | Offset in Vector Table | Vector Name | Cleared by DMA | Index in ICR to Program | Description |
|---------------|------------------------|-------------|----------------|-------------------------|---------------------------------|
| 40 | 35C _H | - | - | 40 | Reserved |
| 41 | 358 _H | PPG3 | Yes | 41 | Programmable Pulse Generator 3 |
| 42 | 354 _H | PPG4 | Yes | 42 | Programmable Pulse Generator 4 |
| 43 | 350 _H | - | - | 43 | Reserved |
| 44 | 34C _H | PPG6 | Yes | 44 | Programmable Pulse Generator 6 |
| 45 | 348 _H | PPG7 | Yes | 45 | Programmable Pulse Generator 7 |
| 46 | 344 _H | - | - | 46 | Reserved |
| 47 | 340 _H | - | - | 47 | Reserved |
| 48 | 33C _H | - | - | 48 | Reserved |
| 49 | 338 _H | - | - | 49 | Reserved |
| 50 | 334 _H | PPG12 | Yes | 50 | Programmable Pulse Generator 12 |
| 51 | 330 _H | - | - | 51 | Reserved |
| 52 | 32C _H | PPG14 | Yes | 52 | Programmable Pulse Generator 14 |
| 53 | 328 _H | - | - | 53 | Reserved |
| 54 | 324 _H | - | - | 54 | Reserved |
| 55 | 320 _H | - | - | 55 | Reserved |
| 56 | 31C _H | - | - | 56 | Reserved |
| 57 | 318 _H | - | - | 57 | Reserved |
| 58 | 314 _H | - | - | 58 | Reserved |
| 59 | 310 _H | RLT1 | Yes | 59 | Reload Timer 1 |
| 60 | 30C _H | - | - | 60 | Reserved |
| 61 | 308 _H | RLT3 | Yes | 61 | Reload Timer 3 |
| 62 | 304 _H | - | - | 62 | Reserved |
| 63 | 300 _H | - | - | 63 | Reserved |
| 64 | 2FC _H | RLT6 | Yes | 64 | Reload Timer 6 |
| 65 | 2F8 _H | ICU0 | Yes | 65 | Input Capture Unit 0 |
| 66 | 2F4 _H | ICU1 | Yes | 66 | Input Capture Unit 1 |
| 67 | 2F0 _H | - | - | 67 | Reserved |
| 68 | 2EC _H | - | - | 68 | Reserved |
| 69 | 2E8 _H | ICU4 | Yes | 69 | Input Capture Unit 4 |
| 70 | 2E4 _H | ICU5 | Yes | 70 | Input Capture Unit 5 |
| 71 | 2E0 _H | ICU6 | Yes | 71 | Input Capture Unit 6 |
| 72 | 2DC _H | - | - | 72 | Reserved |
| 73 | 2D8 _H | - | - | 73 | Reserved |
| 74 | 2D4 _H | ICU9 | Yes | 74 | Input Capture Unit 9 |
| 75 | 2D0 _H | ICU10 | Yes | 75 | Input Capture Unit 10 |
| 76 | 2CC _H | - | - | 76 | Reserved |
| 77 | 2C8 _H | OCU0 | Yes | 77 | Output Compare Unit 0 |
| 78 | 2C4 _H | OCU1 | Yes | 78 | Output Compare Unit 1 |
| 79 | 2C0 _H | - | - | 79 | Reserved |
| 80 | 2BC _H | - | - | 80 | Reserved |

| Vector Number | Offset in Vector Table | Vector Name | Cleared by DMA | Index in ICR to Program | Description |
|---------------|------------------------|-------------|----------------|-------------------------|------------------------|
| 81 | 2B8 _H | OCU4 | Yes | 81 | Output Compare Unit 4 |
| 82 | 2B4 _H | - | - | 82 | Reserved |
| 83 | 2B0 _H | OCU6 | Yes | 83 | Output Compare Unit 6 |
| 84 | 2AC _H | OCU7 | Yes | 84 | Output Compare Unit 7 |
| 85 | 2A8 _H | - | - | 85 | Reserved |
| 86 | 2A4 _H | - | - | 86 | Reserved |
| 87 | 2A0 _H | - | - | 87 | Reserved |
| 88 | 29C _H | - | - | 88 | Reserved |
| 89 | 298 _H | FRT0 | Yes | 89 | Free-Running Timer 0 |
| 90 | 294 _H | FRT1 | Yes | 90 | Free-Running Timer 1 |
| 91 | 290 _H | FRT2 | Yes | 91 | Free-Running Timer 2 |
| 92 | 28C _H | FRT3 | Yes | 92 | Free-Running Timer 3 |
| 93 | 288 _H | RTC0 | No | 93 | Real Time Clock |
| 94 | 284 _H | CAL0 | No | 94 | Clock Calibration Unit |
| 95 | 280 _H | - | - | 95 | Reserved |
| 96 | 27C _H | - | - | 96 | Reserved |
| 97 | 278 _H | - | - | 97 | Reserved |
| 98 | 274 _H | ADC0 | Yes | 98 | A/D Converter 0 |
| 99 | 270 _H | - | - | 99 | Reserved |
| 100 | 26C _H | - | - | 100 | Reserved |
| 101 | 268 _H | - | - | 101 | Reserved |
| 102 | 264 _H | - | - | 102 | Reserved |
| 103 | 260 _H | - | - | 103 | Reserved |
| 104 | 25C _H | - | - | 104 | Reserved |
| 105 | 258 _H | LINR2 | Yes | 105 | LIN USART 2 RX |
| 106 | 254 _H | LINT2 | Yes | 106 | LIN USART 2 TX |
| 107 | 250 _H | - | - | 107 | Reserved |
| 108 | 24C _H | - | - | 108 | Reserved |
| 109 | 248 _H | - | - | 109 | Reserved |
| 110 | 244 _H | - | - | 110 | Reserved |
| 111 | 240 _H | - | - | 111 | Reserved |
| 112 | 23C _H | - | - | 112 | Reserved |
| 113 | 238 _H | - | - | 113 | Reserved |
| 114 | 234 _H | - | - | 114 | Reserved |
| 115 | 230 _H | LINR7 | Yes | 115 | LIN USART 7 RX |
| 116 | 22C _H | LINT7 | Yes | 116 | LIN USART 7 TX |
| 117 | 228 _H | LINR8 | Yes | 117 | LIN USART 8 RX |
| 118 | 224 _H | LINT8 | Yes | 118 | LIN USART 8 TX |
| 119 | 220 _H | - | - | 119 | Reserved |
| 120 | 21C _H | - | - | 120 | Reserved |
| 121 | 218 _H | - | - | 121 | Reserved |

CAUTION:

The occurrence of latch-up not only causes loss of reliability in the semiconductor device, but can cause injury or damage from high heat, smoke or flame. To prevent this from happening, do the following:

1. *Be sure that voltages applied to pins do not exceed the absolute maximum ratings. This should include attention to abnormal noise, surge levels, etc.*
2. *Be sure that abnormal current flows do not occur during the power-on sequence.*

■ Observance of Safety Regulations and Standards

Most countries in the world have established standards and regulations regarding safety, protection from electromagnetic interference, etc. Customers are requested to observe applicable regulations and standards in the design of products.

■ Fail-Safe Design

Any semiconductor devices have inherently a certain rate of failure. You must protect against injury, damage or loss from such failures by incorporating safety design measures into your facility and equipment such as redundancy, fire protection, and prevention of over-current levels and other abnormal operating conditions.

■ Precautions Related to Usage of Devices

Cypress semiconductor devices are intended for use in standard applications (computers, office automation and other office equipment, industrial, communications, and measurement equipment, personal or household devices, etc.).

CAUTION:

Customers considering the use of our products in special applications where failure or abnormal operation may directly affect human lives or cause physical injury or property damage, or where extremely high levels of reliability are demanded (such as aerospace systems, atomic energy controls, sea floor repeaters, vehicle operating controls, medical devices for life support, etc.) are requested to consult with sales representatives before such use. The company will not be responsible for damages arising from such use without prior approval.

12.2 Precautions for Package Mounting

Package mounting may be either lead insertion type or surface mount type. In either case, for heat resistance during soldering, you should only mount under Cypress's recommended conditions. For detailed information about mount conditions, contact your sales representative.

■ Lead Insertion Type

Mounting of lead insertion type packages onto printed circuit boards may be done by two methods: direct soldering on the board, or mounting by using a socket.

Direct mounting onto boards normally involves processes for inserting leads into through-holes on the board and using the flow soldering (wave soldering) method of applying liquid solder. In this case, the soldering process usually causes leads to be subjected to thermal stress in excess of the absolute ratings for storage temperature. Mounting processes should conform to Cypress recommended mounting conditions.

If socket mounting is used, differences in surface treatment of the socket contacts and IC lead surfaces can lead to contact deterioration after long periods. For this reason it is recommended that the surface treatment of socket contacts and IC leads be verified before mounting.

■ Surface Mount Type

Surface mount packaging has longer and thinner leads than lead-insertion packaging, and therefore leads are more easily deformed or bent. The use of packages with higher pin counts and narrower pin pitch results in increased susceptibility to open connections caused by deformed pins, or shorting due to solder bridges.

You must use appropriate mounting techniques. Cypress recommends the solder reflow method, and has established a ranking of mounting conditions for each product. Users are advised to mount packages in accordance with Cypress ranking of recommended conditions.

■ Lead-Free Packaging

CAUTION:

When ball grid array (BGA) packages with Sn-Ag-Cu balls are mounted using Sn-Pb eutectic soldering, junction strength may be reduced under some conditions of use.

■ Storage of Semiconductor Devices

Because plastic chip packages are formed from plastic resins, exposure to natural environmental conditions will cause absorption of moisture. During mounting, the application of heat to a package that has absorbed moisture can cause surfaces to peel, reducing moisture resistance and causing packages to crack. To prevent, do the following:

1. Avoid exposure to rapid temperature changes, which cause moisture to condense inside the product. Store products in locations where temperature changes are slight.
2. Use dry boxes for product storage. Products should be stored below 70% relative humidity, and at temperatures between 5°C and 30°C. When you open Dry Package that recommends humidity 40% to 70% relative humidity.
3. When necessary, Cypress packages semiconductor devices in highly moisture-resistant aluminum laminate bags, with a silica gel desiccant. Devices should be sealed in their aluminum laminate bags for storage.
4. Avoid storing packages where they are exposed to corrosive gases or high levels of dust.

■ Baking

Packages that have absorbed moisture may be de-moisturized by baking (heat drying). Follow the Cypress recommended conditions for baking.

Condition: 125°C/24 h

■ Static Electricity

Because semiconductor devices are particularly susceptible to damage by static electricity, you must take the following precautions:

1. Maintain relative humidity in the working environment between 40% and 70%. Use of an apparatus for ion generation may be needed to remove electricity.
2. Electrically ground all conveyors, solder vessels, soldering irons and peripheral equipment.
3. Eliminate static body electricity by the use of rings or bracelets connected to ground through high resistance (on the level of 1 MΩ). Wearing of conductive clothing and shoes, use of conductive floor mats and other measures to minimize shock loads is recommended.
4. Ground all fixtures and instruments, or protect with anti-static measures.
5. Avoid the use of styro foam or other highly static-prone materials for storage of completed board assemblies.

12.3 Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.

For reliable performance, do the following:

1. Humidity

Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.

2. Discharge of Static Electricity

When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.

3. Corrosive Gases, Dust, or Oil

Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.

4. Radiation, Including Cosmic Radiation

Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.

5. Smoke, Flame

CAUTION:

Plastic molded devices are flammable, and therefore should not be used near combustible substances. If devices begin to smoke or burn, there is danger of the release of toxic gases.

Customers considering the use of Cypress products in other special environmental conditions should consult with sales representatives.

13. Handling Devices

Special Care is Required for the Following when Handling the Device:

- Latch-up prevention
- Unused pins handling
- External clock usage
- Notes on PLL clock mode operation
- Power supply pins (V_{CC}/V_{SS})
- Crystal oscillator and ceramic resonator circuit
- Turn on sequence of power supply to A/D converter and analog inputs
- Pin handling when not using the A/D converter
- Notes on Power-on
- Stabilization of power supply voltage
- Serial communication
- Mode Pin (MD)

13.1 Latch-Up Prevention

CMOS IC chips may suffer latch-up under the following conditions:

- A voltage higher than V_{CC} or lower than V_{SS} is applied to an input or output pin.
- A voltage higher than the rated voltage is applied between V_{CC} pins and V_{SS} pins.
- The AV_{CC} power supply is applied before the V_{CC} voltage.

Latch-up may increase the power supply current dramatically, causing thermal damages to the device.

For the same reason, extra care is required to not let the analog power-supply voltage (AV_{CC} , $AVRH$) exceed the digital power-supply voltage.

13.2 Unused Pins Handling

Unused input pins can be left open when the input is disabled (corresponding bit of Port Input Enable register $PIER = 0$).

Leaving unused input pins open when the input is enabled may result in misbehavior and possible permanent damage of the device. To prevent latch-up, they must therefore be pulled up or pulled down through resistors which should be more than $2k\Omega$.

Unused bidirectional pins can be set either to the output state and be then left open, or to the input state with either input disabled or external pull-up/pull-down resistor as described above.

13.3 External Clock Usage

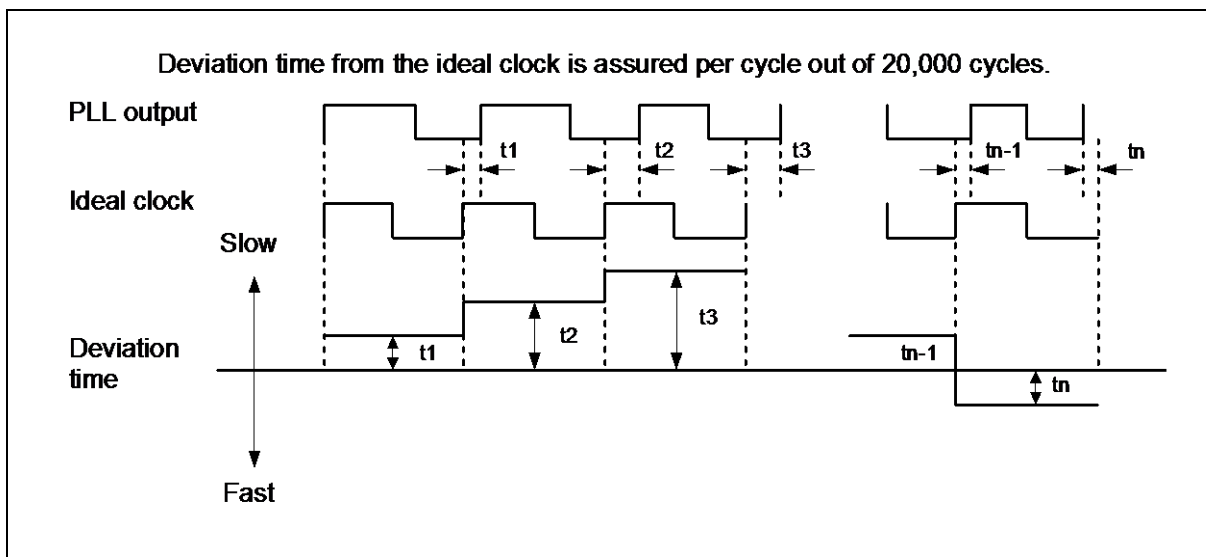
The permitted frequency range of an external clock depends on the oscillator type and configuration.

See

14.4.5 Operating Conditions of PLL

($V_{CC} = AV_{CC} = 2.7V$ to $5.5V$, $V_{SS} = AV_{SS} = 0V$, $T_A = -40^{\circ}C$ to $+125^{\circ}C$)

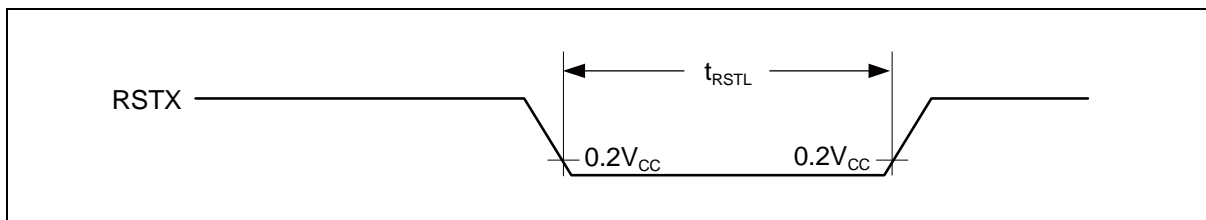
| Parameter | Symbol | Value | | | Unit | Remarks |
|---|--------------|-------|-----|-----|------|--|
| | | Min | Typ | Max | | |
| PLL oscillation stabilization wait time | t_{LOCK} | 1 | - | 4 | ms | For CLKMC = 4MHz |
| PLL input clock frequency | f_{PLLI} | 4 | - | 8 | MHz | |
| PLL oscillation clock frequency | f_{CLKVCO} | 56 | - | 108 | MHz | Permitted VCO output frequency of PLL (CLKVCO) |
| PLL phase jitter | t_{PSKEW} | -5 | - | +5 | ns | For CLKMC (PLL input clock) $\geq 4MHz$ |



14.4.6 Reset Input

($V_{CC} = AV_{CC} = 2.7V$ to $5.5V$, $V_{SS} = AV_{SS} = 0V$, $T_A = -40^{\circ}C$ to $+125^{\circ}C$)

| Parameter | Symbol | Pin Name | Value | | Unit |
|-------------------------------|------------|----------|-------|-----|---------|
| | | | Min | Max | |
| Reset input time | t_{RSTL} | RSTX | 10 | - | μs |
| Rejection of reset input time | | | 1 | - | μs |

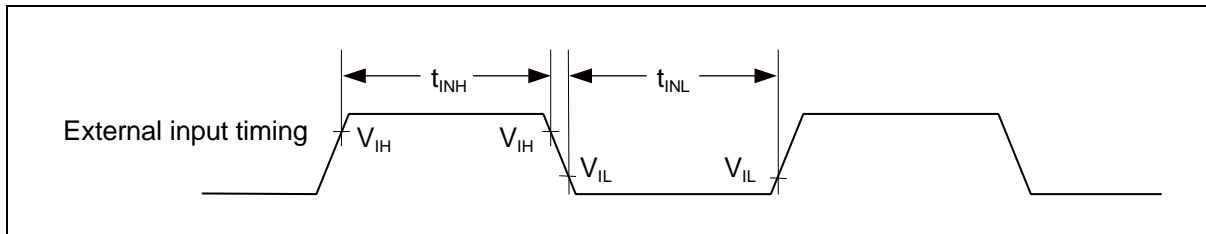


14.4.9 External Input Timing

($V_{CC} = AV_{CC} = 2.7V$ to $5.5V$, $V_{SS} = AV_{SS} = 0V$, $T_A = -40^{\circ}C$ to $+125^{\circ}C$)

| Parameter | Symbol | Pin Name | Value | | Unit | Remarks |
|-------------------|-----------------------|-----------------------|--|-----|------|--|
| | | | Min | Max | | |
| Input pulse width | t_{INH} , t_{INL} | Pnn_m | $2t_{CLKP1} + 200$ ($t_{CLKP1}=1/t_{CLKP1}$)* | - | ns | General Purpose I/O |
| | | ADTG_R | | | | A/D Converter trigger input |
| | | TINn | | | | Reload Timer |
| | | TTGn | | | | PPG trigger input |
| | | INn | | | | Input Capture |
| | | AINn, BINn, ZINn | | | | Quadrature Position/Revolution Counter |
| | | INTn, INTn_R, INTn_R1 | 200 | - | ns | External Interrupt |
| | | NMI | | | | Non-Maskable Interrupt |

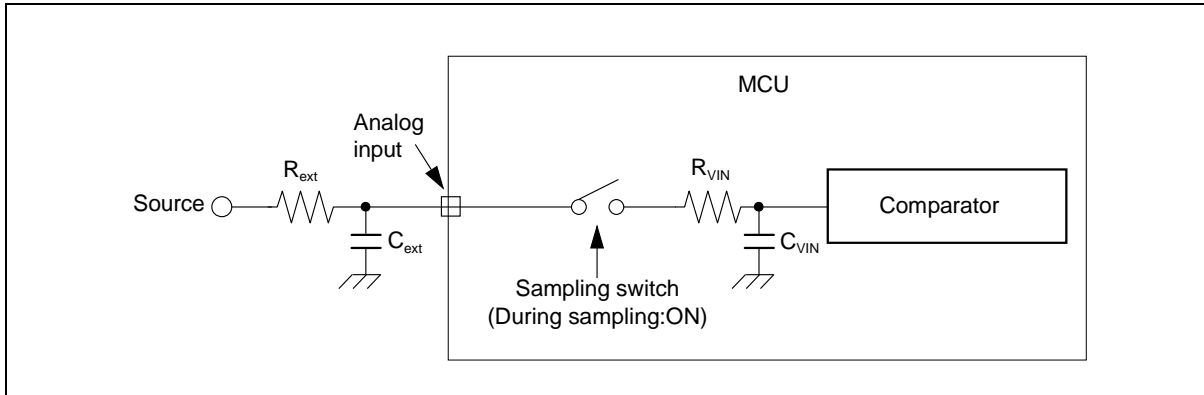
*: t_{CLKP1} indicates the peripheral clock1 (CLKP1) cycle time except stop when in stop mode.



14.5.2 Accuracy and Setting of the A/D Converter Sampling Time

If the external impedance is too high or the sampling time too short, the analog voltage charged to the internal sample and hold capacitor is insufficient, adversely affecting the A/D conversion precision.

To satisfy the A/D conversion precision, a sufficient sampling time must be selected. The required sampling time (T_{samp}) depends on the external driving impedance R_{ext} , the board capacitance of the A/D converter input pin C_{ext} and the AV_{CC} voltage level. The following replacement model can be used for the calculation:



R_{ext} : External driving impedance

C_{ext} : Capacitance of PCB at A/D converter input

C_{VIN} : Analog input capacity (I/O, analog switch and ADC are contained)

R_{VIN} : Analog input impedance (I/O, analog switch and ADC are contained)

The following approximation formula for the replacement model above can be used:

$$T_{\text{samp}} = 7.62 \times (R_{\text{ext}} \times C_{\text{ext}} + (R_{\text{ext}} + R_{\text{VIN}}) \times C_{\text{VIN}})$$

- Do not select a sampling time below the absolute minimum permitted value.
($0.5\mu\text{s}$ for $4.5\text{V} \leq AV_{\text{CC}} \leq 5.5\text{V}$, $1.2\mu\text{s}$ for $2.7\text{V} \leq AV_{\text{CC}} < 4.5\text{V}$)
- If the sampling time cannot be sufficient, connect a capacitor of about $0.1\mu\text{F}$ to the analog input pin.
- A big external driving impedance also adversely affects the A/D conversion precision due to the pin input leakage current I_{IL} (static current before the sampling switch) or the analog input leakage current I_{AIN} (total leakage current of pin input and comparator during sampling). The effect of the pin input leakage current I_{IL} cannot be compensated by an external capacitor.
- The accuracy gets worse as $|AV_{\text{RH}} - AV_{\text{SS}}|$ becomes smaller.

14.5.3 Definition of A/D Converter Terms

- Resolution : Analog variation that is recognized by an A/D converter.
- Nonlinearity error : Deviation of the actual conversion characteristics from a straight line that connects the zero transition point ($0b0000000000 \longleftrightarrow 0b0000000001$) to the full-scale transition point ($0b1111111110 \longleftrightarrow 0b1111111111$).
- Differential nonlinearity error : Deviation from the ideal value of the input voltage that is required to change the output code by 1LSB.
- Total error : Difference between the actual value and the theoretical value. The total error includes zero transition error, full-scale transition error and nonlinearity error.
- Zero transition voltage: Input voltage which results in the minimum conversion value.
- Full scale transition voltage: Input voltage which results in the maximum conversion value.

16. Ordering Information

MCU with CAN Controller

| Part Number | Flash Memory | Package* |
|-------------------------|-------------------|------------------------------|
| CY96F612RBPMC-GS-UJE1 | Flash A (64.5KB) | 48-pin plastic LQFP (LQA048) |
| CY96F612RBPMC-GS-UJE2 | | |
| CY96F613RBPMC-GS-UJE1 | Flash A (96.5KB) | 48-pin plastic LQFP (LQA048) |
| CY96F613RBPMC-GS-UJE2 | | |
| CY96F613RBPMC-GS-UJERE2 | | |
| CY96F615RBPMC-GS-UJE1 | Flash A (160.5KB) | 48-pin plastic LQFP (LQA048) |
| CY96F615RBPMC-GS-UJE2 | | |
| CY96F615RBPMC-GS-UJERE2 | | |

*: For details about package, see "[Package Dimension](#)".

MCU without CAN Controller

| Part Number | Flash Memory | Package* |
|-----------------------|-------------------|------------------------------|
| CY96F612ABPMC-GS-UJE1 | Flash A (64.5KB) | 48-pin plastic LQFP (LQA048) |
| CY96F612ABPMC-GS-UJE2 | | |
| CY96F613ABPMC-GS-UJE1 | Flash A (96.5KB) | 48-pin plastic LQFP (LQA048) |
| CY96F613ABPMC-GS-UJE2 | | |
| CY96F615ABPMC-GS-UJE1 | Flash A (160.5KB) | 48-pin plastic LQFP (LQA048) |

*: For details about package, see "[Package Dimension](#)".

18. Major Changes

Spanion Publication Number: MB96610_DS704-00007

| Page | Section | Change Results |
|--------------|--|--|
| Revision 3.0 | | |
| 4 | ■FEATURES | Changed the description of "External Interrupts" Interrupt mask and pending bit per channel Interrupt mask bit per channel |
| 23 to 26 | ■HANDLING PRECAUTIONS | Added a section |
| 34 | ■ELECTRICAL CHARACTERISTICS 3. DC Characteristics (1) Current Rating | Changed the Conditions for I_{CCSRCH} $CLKS1/2 = CLKB = CLKP1/2 = CLKRC = 2MHz$, $CLKS1/2 = CLKP1/2 = CLKRC = 2MHz$, |
| | | Changed the Conditions for I_{CCSRCL} $CLKS1/2 = CLKB = CLKP1/2 = CLKRC = 100kHz$ $CLKS1/2 = CLKP1/2 = CLKRC = 100kHz$ |
| | | Changed the Conditions for I_{CCTPLL} PLL Timer mode with $CLKP1 = 32MHz$ PLL Timer mode with $CLKPLL = 32MHz$ |
| 35 | | Changed the Value of "Power supply current in Timer modes" I_{CCTPLL} Typ: $2480\mu A \rightarrow 1800\mu A$ ($T_A = +25^{\circ}C$) Max: $2710\mu A \rightarrow 2245\mu A$ ($T_A = +25^{\circ}C$) Max: $3985\mu A \rightarrow 3165\mu A$ ($T_A = +105^{\circ}C$) Max: $4830\mu A \rightarrow 3975\mu A$ ($T_A = +125^{\circ}C$) |
| | | Changed the Conditions for I_{CCTRCL} RC Timer mode with $CLKRC = 100kHz$, SMCR:LPMSS = 0 ($CLKPLL$, $CLKMC$ and $CLKSC$ stopped) RC Timer mode with $CLKRC = 100kHz$ ($CLKPLL$, $CLKMC$ and $CLKSC$ stopped) |
| 36 | | Changed the annotation *2 Power supply for "On Chip Debugger" part is not included. Power supply current in Run mode does not include Flash Write / Erase current. The current for "On Chip Debugger" part is not included. |
| 47 | 5. A/D Converter (2) Accuracy and Setting of the A/D Converter Sampling Time | Deleted the unit "[Min]" from approximation formula of Sampling time |
| 52 | 7. Flash Memory Write/Erase Characteristics | Changed the condition ($V_{CC} = AV_{CC} = 2.7V$ to $5.5V$, $V_D = 1.8V \pm 0.15V$, $V_{SS} = AV_{SS} = 0V$, $T_A = -40^{\circ}C$ to $+125^{\circ}C$) ($V_{CC} = AV_{CC} = 2.7V$ to $5.5V$, $V_{SS} = AV_{SS} = 0V$, $T_A = -40^{\circ}C$ to $+125^{\circ}C$) |

| Page | Section | Change Results |
|------|--------------------------|--|
| 58 | 16. Ordering Information | <p>Revised Marketing Part Numbers as follows:</p> <p>Before)</p> <p>MCU with CAN Controller MB96F612RBPMC-GSE1 MB96F612RBPMC-GS-UJE1 MB96F612RBPMC-GSE2 MB96F612RBPMC-GS-UJE2 MB96F612RBPMC-GTE1 MB96F613RBPMC-GSE1 MB96F613RBPMC-GS-UJE1 MB96F613RBPMC-GSE2 MB96F613RBPMC-GS-UJE2 MB96F613RBPMC-GTE1 MB96F615RBPMC-GSE1 MB96F615RBPMC-GS-UJE1 MB96F615RBPMC-GSE2 MB96F615RBPMC-GS-UJE2 MB96F615RBPMC-GTE1</p> <p>MCU without CAN Controller MB96F612ABPMC-GSE1 MB96F612ABPMC-GS-UJE1 MB96F612ABPMC-GSE2 MB96F612ABPMC-GS-UJE2 MB96F612ABPMC-GTE1 MB96F613ABPMC-GSE1 MB96F613ABPMC-GS-UJE1 MB96F613ABPMC-GSE2 MB96F613ABPMC-GS-UJE2 MB96F613ABPMC-GTE1 MB96F615ABPMC-GSE1 MB96F615ABPMC-GS-UJE1 MB96F615ABPMC-GSE2 MB96F615ABPMC-GTE1</p> |
| 58 | 16. Ordering Information | <p>After)</p> <p>MCU with CAN Controller CY96F612RBPMC-GS-UJE1 CY96F612RBPMC-GS-UJE2 CY96F613RBPMC-GS-UJE1 CY96F613RBPMC-GS-UJE2 CY96F613RBPMC-GS-UJERE2 CY96F615RBPMC-GS-UJE1 CY96F615RBPMC-GS-UJE2 CY96F615RBPMC-GS-UJERE2</p> <p>MCU without CAN Controller CY96F612ABPMC-GS-UJE1 CY96F612ABPMC-GS-UJE2 CY96F613ABPMC-GS-UJE1 CY96F613ABPMC-GS-UJE2 CY96F615ABPMC-GS-UJE1</p> |

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